

MOS FIELD EFFECT TRANSISTOR

2SK3356

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3356 is N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

• Super low on-state resistance:

 $R_{\text{DS(on)1}}$ = 8.0 m Ω MAX. (Vgs = 10 V, ID = 38 A)

 $R_{\text{DS(on)2}}$ = 12 m Ω MAX. (VGs = 4 V, ID = 38 A)

- Low Ciss: $C_{iss} = 6300 \, pF \, TYP$.
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	Drain to Source Voltage	VDSS	60	V
	Gate to Source Voltage	VGSS(AC)	±20	V
	Drain Current (DC)	D(DC)	±75	А
	Drain Current (pulse) Note1	D(pulse)	±300	А
ł	Total Power Dissipation (Tc = 25°C)	P _{T1}	135	W
ł	Total Power Dissipation (T _A = 25°C)	P _{T2}	3.0	W
	Channel Temperature	Tch	150	°C
	Storage Temperature	Tstg	-55 to +150	°C
	Single Avalanche Current Note2	las	55	А
	Single Avalanche Energy Note2	Eas	302	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1 %

$$\star$$

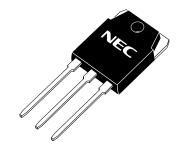
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2. Starting T_{ch} = 25°C, V_{DD} = 30 V, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V



PART NUMBER	PACKAGE		
2SK3356	TO-3P		





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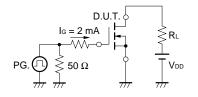
ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNI
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 60 V, V_{GS} = 0 V$			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 V$, $V_{DS} = 0 V$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	$V_{DS} = 10 V, I_{D} = 1 mA$	1.5	2.0	2.5	V
Forward Transfer Admittance	y₁s	Vds = 10 V, Id = 38 A	35	57		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = 10 V, I_D = 38 A$		6.3	8.0	m۵
	RDS(on)2	Vgs = 4 V, Id = 38 A		8.0	12	m۵
Input Capacitance	Ciss	$V_{DS} = 10 V$, $V_{GS} = 0 V$, $f = 1 MHz$		6300		pF
Output Capacitance	Coss			1000		рF
Reverse Transfer Capacitance	Crss			490		pF
Turn-on Delay Time	td(on)	$I_{D} = 38 A, V_{GS(on)} = 10 V, V_{DD} = 30 V,$		90		ns
Rise Time	tr	R _G = 10 Ω		1000		ns
Turn-off Delay Time	td(off)			300		ns
Fall Time	tr			400		ns
Total Gate Charge	QG	ID=75A , $VDD=48V,VGs=10V$		106		nC
Gate to Source Charge	QGS			20		nC
Gate to Drain Charge	Qgd			30		nC
Body Diode Forward Voltage	VF(S-D)	IF = 75 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 75 A, VGS = 0 V,		55		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		100		nC

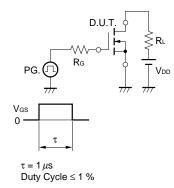
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V} \xrightarrow{\text{Ins}} V_{DD}$

TEST CIRCUIT 3 GATE CHARGE



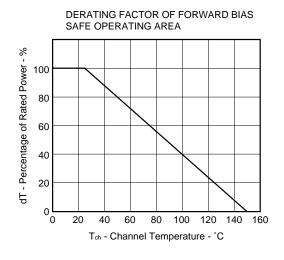
TEST CIRCUIT 2 SWITCHING TIME

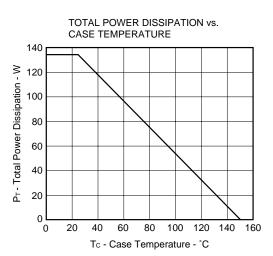


VGS Wave Form	VGS 0 10 % - VGS(on) 90 %
lo Wave Form	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

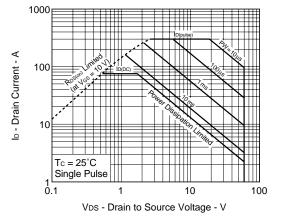
Data Sheet D14133EJ2V0DS

★ TYPICAL CHARACTERISTICS (T_A = 25°C)

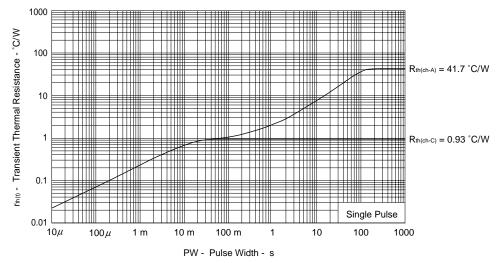




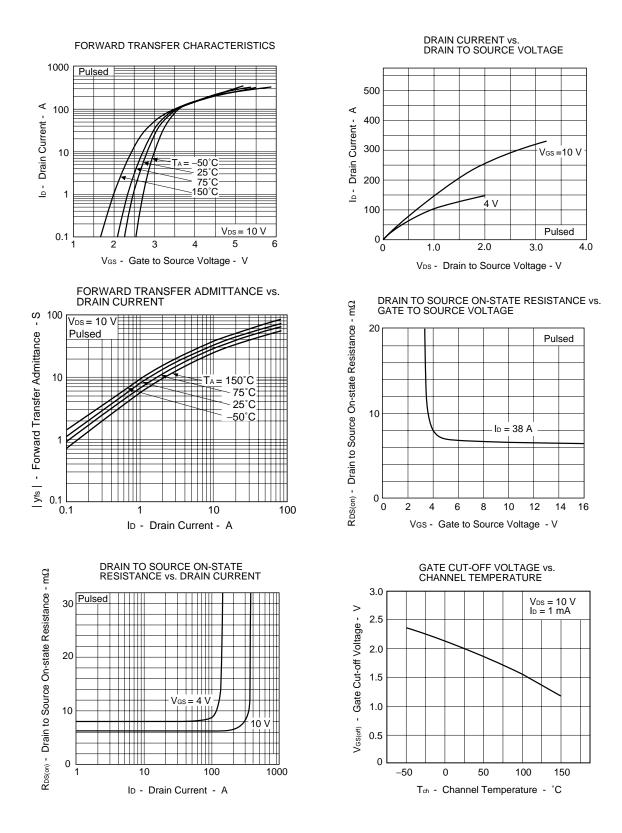
FORWARD BIAS SAFE OPERATING AREA



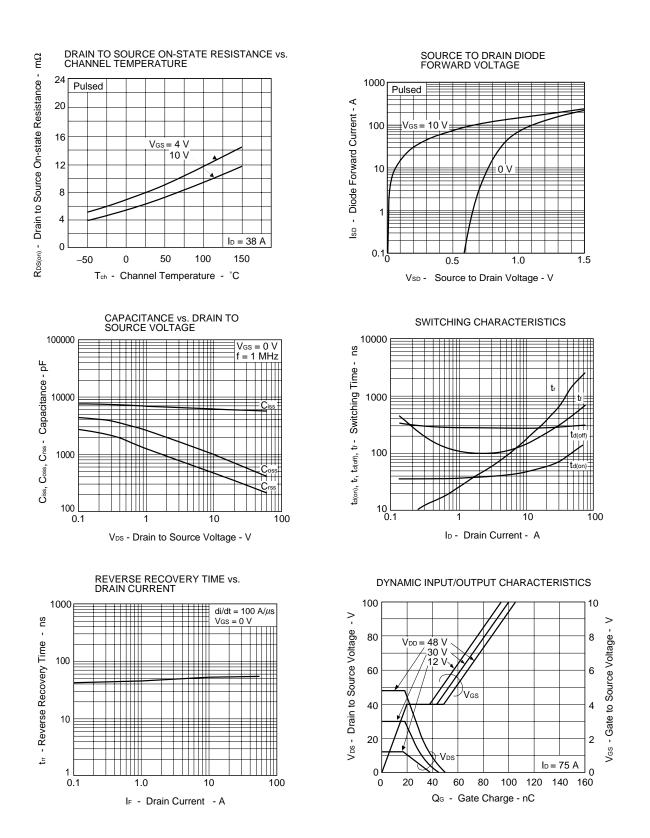
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



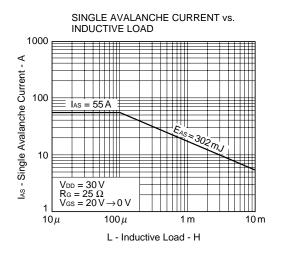
Data Sheet D14133EJ2V0DS

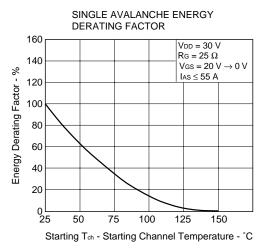


NEC



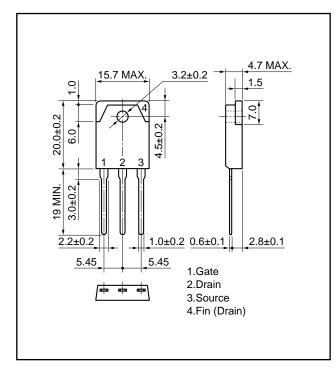
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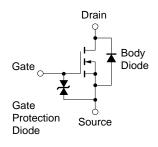


PACKAGE DRAWING (Unit: mm)

TO-3P (MP-88)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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